





SPECIFICATION FOR 3.3V LVPECL SMT TCXO MtronPTI P/N M6300S137

Electrical Specifications:

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Frequency of Operation	Fo		156.250000		MHz	
Frequency Tolerance		-1.0		+1.0	ppm	@ +25°C
		F	requency Stal	bility		
vs. Temperature	Δ F/F			4.6	ppm	(Max-Min)/2
vs. Aging		-3		+3	ppm	1 st year
		-1		+1	ppm	Per year thereafter.
			RF Output			
Output Type		LVPECL Compatible				
Output Load		50 Ω to (V _{CC} – 2)		V		
Logic "1" Level Output	Voh	V _{cc} -1.02			V	
Logic "0" Level Output	Vol			V _{cc} – 1.63	V	
Output Skew			20		ps	LVPECL load
Symmetry (Duty Cycle)	T _{DC}	45		55	%	Ref. at 50% of waveform
Rise/Fall Time	T _R /T _F			0.35	nS	From 20% to 80% V _{CC}
		Supply Vol	Itage & Power	Consumpt	ion	
Operating Voltage	V _{cc}	3.135	3.3	3.465	V	
Operating Current	Icc			130	mA	

Environmental Conditions:

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions	
Operating Temperature	TA	-55		+125	С°		
Storage Temperature	Ts	-55		+125	С°		
Shock	Per MIL-S	Per MIL-STD-202, Method 213, Condition C (100 g's, 6 ms duration, ¹ / ₂ sinewave)					
Vibration	Per MIL-STD-202, Method 201 & 204 (10 g's from 10-2000 Hz)						
Thermal Shock	Per MIL-STD-883, Method 1011, Condition A						
Thermal Cycle	Per MIL-STD-883, Method 1010, Condition B						
Hermeticity	Per MIL-S	TD-202, Me	thod 112 (1 x 10	-8 atm cc/s of	helium)		
Moisture Sensitivity Level (MSL)	MSL 1						
Solderability	Per EIAJ-STD-002						
Max. Soldering Conditions	See Figure 1.						
Package Type	6-pad 5.0 X 7.0 X 1.9 mm leadless ceramic. RoHS compliant.						

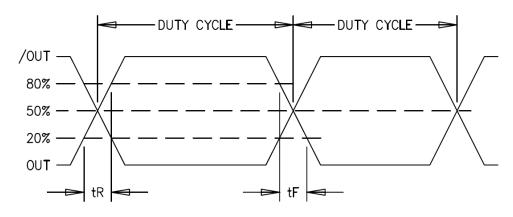




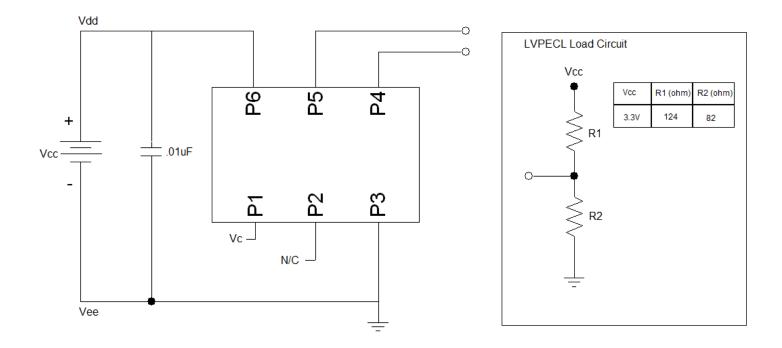


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Output Waveform:



Typical Test Circuit & Load Circuit Diagrams:



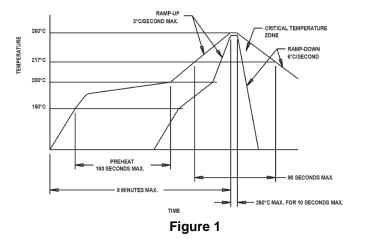




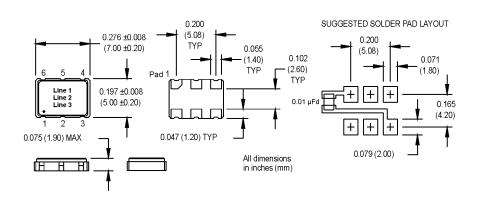


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Soldering Conditions:



Mechanical, Marking, and Pin Out Information:



Datasheet Revision Table:

Date	Rev.	Author	Details of Revision		
03-06-20	Α	BRR	Original release.		